

## Technical Data

## PHOTOCAP<sup>®</sup> 15505P HLT<sup>™</sup>

PHOTOCAP<sup>®</sup> 15505P HLT<sup>™</sup> is an ultra fast cure EVA (ethylene vinyl acetate copolymer) photovoltaic encapsulating film material with HLT<sup>™</sup> higher light transmission in the UV wavelength region. The improved transmission characteristics allow up to 1.5% more solar light to the PV device. This product has similar physical properties, curing kinetics and photo-thermal stability, relative to PHOTOCAP<sup>®</sup> 15420P.

PHOTOCAP 15505P HLT can be used for all crystalline silicon photovoltaic module constructions, and for some thin film photovoltaic designs with back-side PV devices. PHOTOCAP 15505P HLT is provided as rolled film ready for use in thermal lamination processes. The material is self-priming for adhesion to glass.

Properties	Test Method	Units	Condition	Results
	ASTM			
<b>Physical Mechanical</b>				
Tensile Strength	D638	MPa	23 °C, 250 mm/min elongation rate	18
Ultimate Elongation	D638	%	23 °C, 250 mm/min elongation rate	630
10% Secant Modulus	D638	MPa	23 °C, 250 mm/min elongation rate	9
Hardness	D2240	Shore A/D	23 °C	69 / 21
Adhesion to Glass	STR	N/cm	23 °C	70-90
MVTR	F1249	g/m <sup>2</sup> /day	25 °C/100sccm flow, 100%RH	18
Water Absorption	D570	wt%	23 °C	< 0.1
<b>Optical</b>				
Optical Transmission	E424	%	23 °C, 0.46 mm thickness	91
UV Cutoff Wavelength	E424	nm	23 °C, 0.46 mm thickness	305
Refractive Index	D542	-	23 °C, 0.46 mm thickness	1.482
<b>Electrical</b>				
Volume Resistivity	D257	ohm cm	23 °C	>1 x 10 <sup>14</sup>
Dielectric Strength	D149	kV/mm	23 °C, 500V/sec	24

*Tests are made in accordance with the current issue of the ASTM, or other cited test method. Test data reported here are nominal values measured on extruded films, 0.5 mm thick, or compression molded sheets and test bars, which have been cured at 150 °C for 7 minutes with a laboratory press. Optical measurements made with glass-EVA coupons with high transmission solar glass.*

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**AGENCY APPROVALS:**

PHOTOCAP 15505P HLT is a UL listed product in category QIHE2 Photovoltaic Polymeric Materials. Please refer to UL file number E310488.

**PRODUCT VARIATIONS:**

Suffix	Release Paper	Shrinkage	Notes
15505P/UF HLT	Yes	Zero	STR's User Friendly (UF) technology allows sheets to be cut closer to size, resulting in less voids and shifting of ribbon and cells
15505P/UEP HLT	No	Minimal	Paperless UF option, resulting in minimal shrinkage
15505P/PL HLT	No	Higher than UF or UEP	Possesses a greater tendency to shrink but perfectly acceptable for use

**PROCESS GUIDELINES:**

Vacuum Lamination Step		Heat Cure Cycle	
Nominal Temperature	145 - 150 °C	Platen Temperature	145 - 150 °C
Vacuum Range	< 60 mbar	Cure Time	8 min
Evacuation Time	4 min	Applied Bladder Pressure	910 mbar
EVA Melting Range Via DSC	60 - 70 °C	Target Temperature within the Encapsulant	140 °C
		Time Above the Target Temperature	> 3 min

*Processing conditions shown here are a recommended starting point for a crystalline silicon photovoltaic module processed with a typical 2-step vacuum lamination system. Actual values required to achieve desired cure levels will depend on the specific PV module design and the lamination process used.*

*The temperature of the encapsulant should be at or above the EVA melting range before pressure is applied for the cure cycle. The encapsulant should reach the target temperature during the cure cycle, and should remain above that target temperature for the time shown. Temperatures within encapsulant should be periodically measured with embedded thermocouples to assess temperature uniformity of the laminator heating plate and the rate of heat transfer to the PV module. More information about how to laminate PV modules with PHOTOCAP encapsulants is available from STR.*

All PHOTOCAP grades are based upon over 30 years of STR's commercial experience in the photovoltaic market.

For further information, please contact the nearest Specialized Technology Resources office or agent.

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